**Vishay Semiconductors** 

# Half Bridge IGBT Power Module, 600 V, 50 A



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**INT-A-PAK** 

PRIMARY CHARACTERISTICS				
V <sub>CES</sub>	600 V			
I <sub>C</sub> at T <sub>C</sub> = 80 °C	50 A			
V <sub>CE(on)</sub> (typical) at I <sub>C</sub> = 50 A, 25 °C	1.65 V			
Speed 8 kHz to 30 kHz				
Package INT-A-PAK				
Circuit configuration	Half bridge			

### **FEATURES**

- Low V<sub>CE(on)</sub> trench IGBT technology
- 5 µs short circuit capability
- V<sub>CE(on)</sub> with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- · Fast and soft reverse recovery antiparallel FWD
- · Isolated copper baseplate using DCB (direct copper bonding) technology
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **TYPICAL APPLICATIONS**

- UPS (uninterruptable power supply)
- Electronic welders
- · Switching mode power supplies

## DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as UPS and SMPS.

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V <sub>CES</sub>		600	v	
Gate to emitter voltage	V <sub>GES</sub>		± 20	v	
Collector current		T <sub>C</sub> = 25 °C	85		
	Ι <sub>C</sub>	T <sub>C</sub> = 80 °C	50		
Pulsed collector current	I <sub>CM</sub> <sup>(1)</sup>	t <sub>p</sub> = 1 ms	100	А	
Diode continuous forward current	١ <sub>F</sub>	T <sub>C</sub> = 80 °C	50		
Diode maximum forward current	I <sub>FM</sub> <sup>(1)</sup>	t <sub>p</sub> = 1 ms	100		
Maximum power dissipation	PD	T <sub>J</sub> = 175 °C	208	W	
Short circuit withstand time	t <sub>SC</sub>	T <sub>C</sub> = 125 °C	5	μs	
RMS isolation voltage	V <sub>ISOL</sub>	f = 50 Hz, t = 1 min	4000	V	

#### Note

<sup>(1)</sup> Repetitive rating: pulse width limited by maximum junction temperature

<b>IGBT ELECTRICAL SPECIFICATIONS</b> ( $T_c = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V <sub>(BR)CES</sub>	T <sub>J</sub> = 25 °C	600	-	-	
Collector to emitter voltage	Maria a		1.65	2.10	v	
Collector to entitler voltage	V <sub>CE(on)</sub>	$V_{GE}$ = 15 V, I <sub>C</sub> = 50 A, T <sub>J</sub> = 175 °C	-	2.05	-	v
Gate to emitter threshold voltage	V <sub>GE(th)</sub>	$V_{CE}$ = $V_{GE}$ , $I_C$ = 1.4 mA, $T_J$ = 25 °C	4.0	4.9	6.5	
Collector cut-off current	I <sub>CES</sub>	$V_{CE} = V_{CES}, V_{GE} = 0 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	-	1.0	mA
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = V_{GES}, V_{CE} = 0 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	-	400	nA

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SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		TYP.	MAX.	UNITS
Turn-on delay time	t <sub>d(on)</sub>		-	58	-	ns mJ
Rise time	t <sub>r</sub>		-	31	-	
Turn-off delay time	t <sub>d(off)</sub>	$V_{CC} = 300 \text{ V}, \text{ I}_{C} = 50 \text{ A}, \text{ R}_{g} = 3.3 \Omega,$	-	80	-	
Fall time	t <sub>f</sub>	$ \begin{array}{l} {\sf V}_{CC} = 300 \; {\sf V}, \; {\sf I}_{C} = 50 \; {\sf A}, \; {\sf R}_{g} = 3.3 \; \Omega, \\ {\sf V}_{GE} = \pm \; 15 \; {\sf V}, \; {\sf T}_{J} = 25 \; ^{\circ}{\rm C} \end{array} $	-	100	-	
Turn-on switching loss	E <sub>on</sub>		-	0.41	-	
Turn-off switching loss	E <sub>off</sub>		-	0.42	-	
Turn-on delay time	t <sub>d(on)</sub>		-	64	-	ns
Rise time	t <sub>r</sub>		-	37	-	
Turn-off delay time	t <sub>d(off)</sub>	$\begin{array}{l} {\sf V}_{CC} = 300 \; {\sf V},  {\sf I}_{C} = 50 \; {\sf A},  {\sf R}_{g} = 3.3 \; \Omega, \\ {\sf V}_{GE} = \pm \; 15 \; {\sf V},  {\sf T}_{J} = 125 \; ^{\circ}{\rm C} \end{array}$	-	90	-	
Fall time	t <sub>f</sub>		-	117	-	
Turn-on switching loss	E <sub>on</sub>		-	0.69	-	mJ
Turn-off switching loss	E <sub>off</sub>		-	0.69	-	mj
Input capacitance	Cies		-	3.03	-	
Output capacitance	C <sub>oes</sub>	$V_{GE} = 0 V$ , $V_{CE} = 30 V$ , f = 1.0 MHz	-	0.25	-	nF
Reverse transfer capacitance	C <sub>res</sub>		-	0.09	-	
SC data	I <sub>SC</sub>	$\begin{array}{l} t_p \leq 5 \; \mu s, \; V_{GE} = 15 \; V, \; T_J = 125 \; ^\circ C, \\ V_{CC} = 360 \; V, \; V_{CEM} \leq 600 \; V \end{array}$	-	450	-	А
Stray inductance	L <sub>CE</sub>		-	-	30	nH
Module lead resistance, terminal to chip	R <sub>CC'+EE'</sub>		-	0.75	-	mΩ

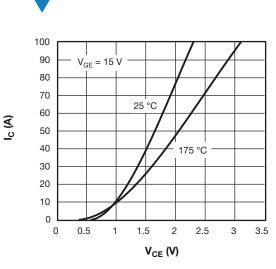
<b>DIODE ELECTRICAL SPECIFICATIONS</b> ( $T_c = 25$ °C unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Forward voltage	¥-	$V_{\rm F}$ $I_{\rm F} = 50  \text{A}$	T <sub>J</sub> = 25 °C	-	1.35	1.75	v	
Torward voltage	٧F		T <sub>J</sub> = 125 °C	-	1.37	-		
	0	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	-	2.3	-		
Reverse recovery charge	Qrr		T <sub>J</sub> = 125 °C	-	4.3	-	μC	
	I <sub>rr</sub>	I <sub>F</sub> = 5	$I_F = 50$ A, $V_R = 300$ V, $R_G = 3.3$ Ω	T <sub>J</sub> = 25 °C	-	33	-	٨
Peak reverse recovery current		$r_{\rm r} = 3.3 \Omega$ $V_{\rm GE} = -15 V$	T <sub>J</sub> = 125 °C	-	58	-	A	
	F		T <sub>J</sub> = 25 °C	-	0.56	-		
Reverse recovery energy	E <sub>rec</sub>		T <sub>J</sub> = 125 °C	-	1.11	-	mJ	

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction temperature range	TJ		-	-	175	°C
Storage temperature range	T <sub>Stg</sub>		-40	-	125	°C
Junction to case IGBT	Р		-	-	0.72	
per ½ module Diode	- R <sub>thJC</sub>		-	-	1.02	K/W
Case to sink (Conductive grease applied)	R <sub>thCS</sub>		-	0.05	-	
Mounting torque		Power terminal screw: M5		2.5 to 5.0		Nm
		Mounting screw: M6		3.0 to 5.0		
Weight		Weight of module	-	150	-	g

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Fig. 1 - IGBT Typical Output Characteristics

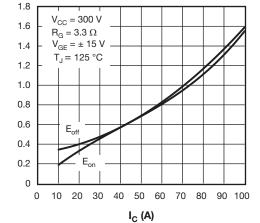


Fig. 2 - IGBT Transfer Characteristics

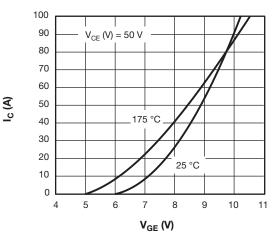


Fig. 3 - IGBT Switching Loss vs. I<sub>C</sub>

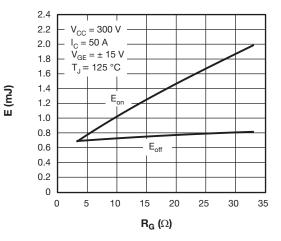
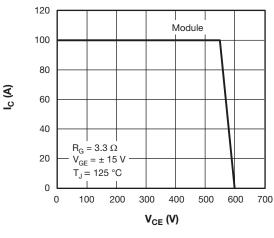


Fig. 4 - IGBT Switching Loss vs. R<sub>G</sub>





E (mJ)

SHAY

# **VS-GT50TP60N**

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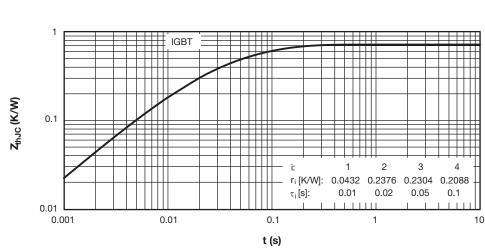
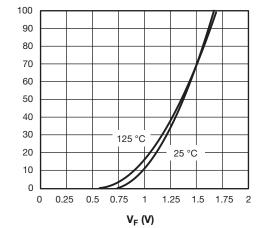
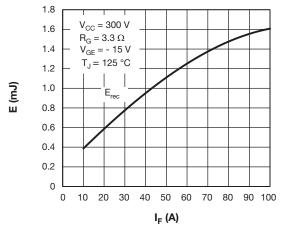


Fig. 6 - IGBT Transient Thermal Impedance



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Fig. 7 - Diode Forward Characteristics





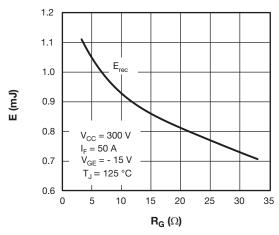


Fig. 9 - Diode Switching Loss vs. R<sub>G</sub>

I<sub>F</sub> (A)

# VS-GT50TP60N

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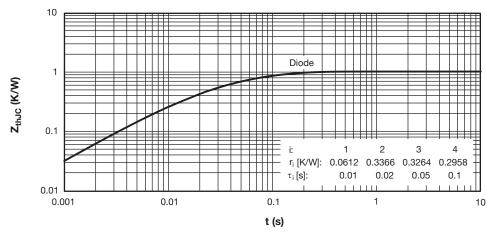
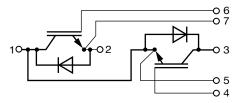


Fig. 10 - Diode Transient Thermal Impedance

## CIRCUIT CONFIGURATION

SHA

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LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95524			

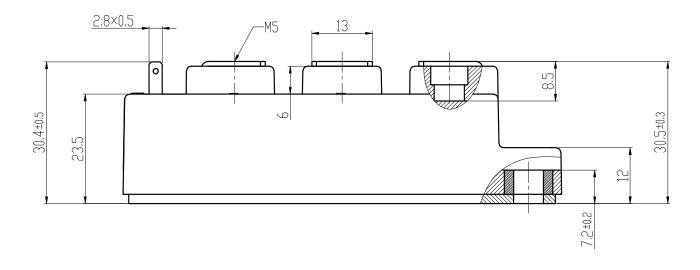
# **Outline Dimensions**

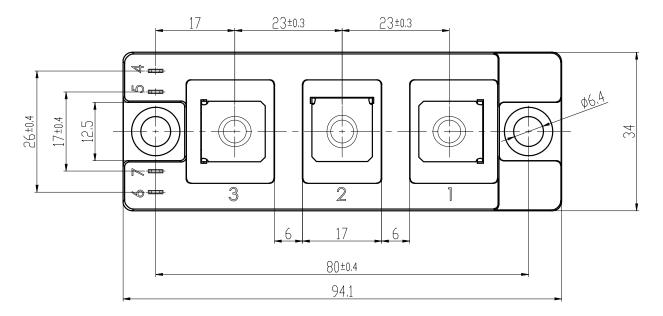


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## **DIMENSIONS** in millimeters (inches)







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